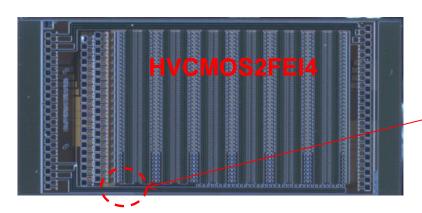
Edge-TCT studies of irradiated HVCMOS sensor (an update)

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on behalf of HVCMOS collaboration

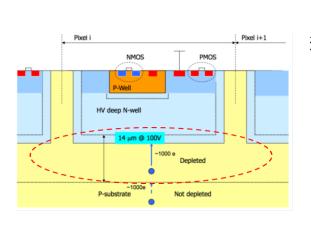
Motivation

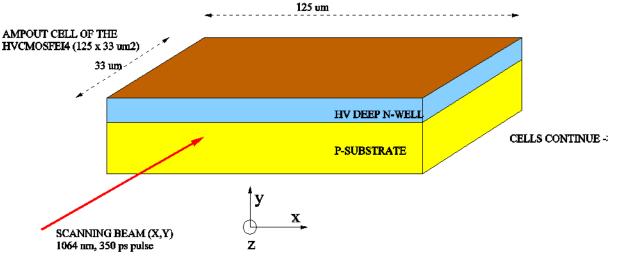
Thanks for the first two speaker, which saved some of my minutes...
 (have a look also our presentation at 24th RD50 meeting)

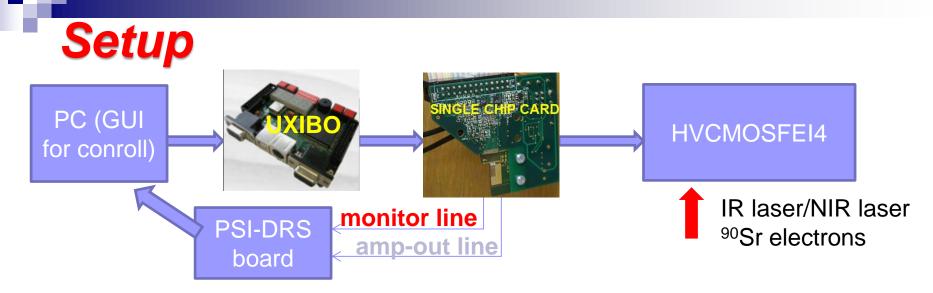


A single cell of 125 x 33 μm^2 was investigated – output to readout after the charge sensitive amplifier.

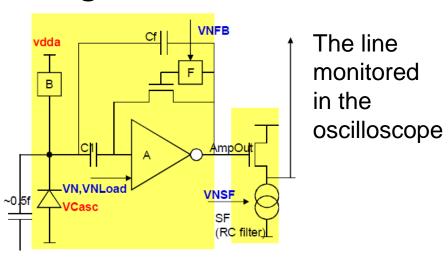
Not ideal (not observing induced current), but good enough!

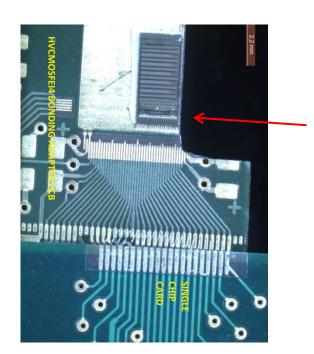




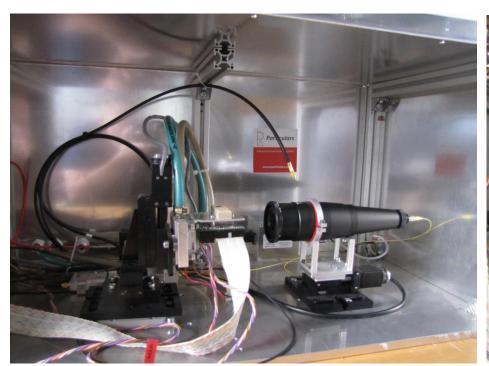


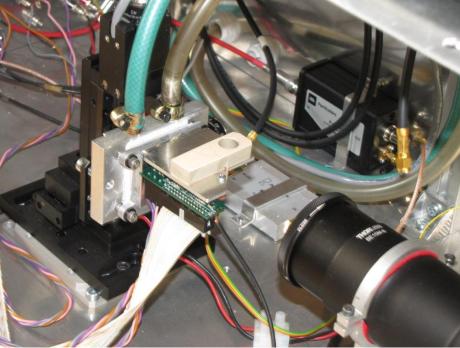
Single cell readout





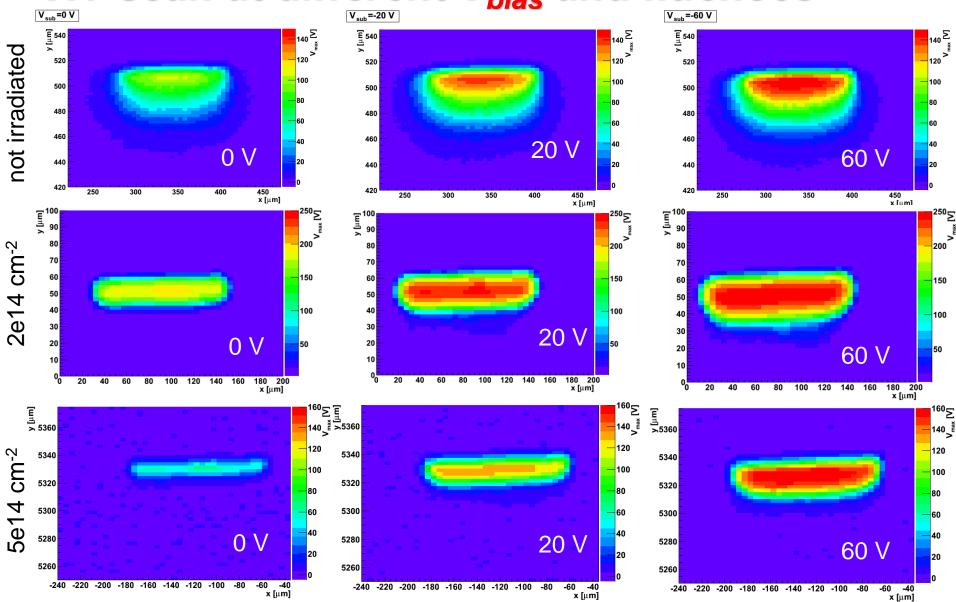
Sample and technique



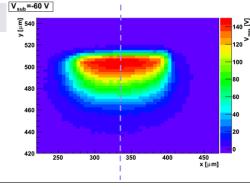


- ➤ A single detector was irradiated in steps with neutrons to 2, 5e14 cm⁻² in steps (80min@60C annealing in between)
- > Particulars Scanning-TCT system used:1060 nm pulse laser, 350 ps, 500 Hz
- At the moment the chip can not be actively cooled with measurements at 24°C
- We FWHM of the beam was around 10 μm (although is seems better with HVCMOS around 7-8 μm see our presentation at 24th RD50 meeting)

XY scan at different V_{bias} and fluences



Charge collection profiles along the depth at the pixel center

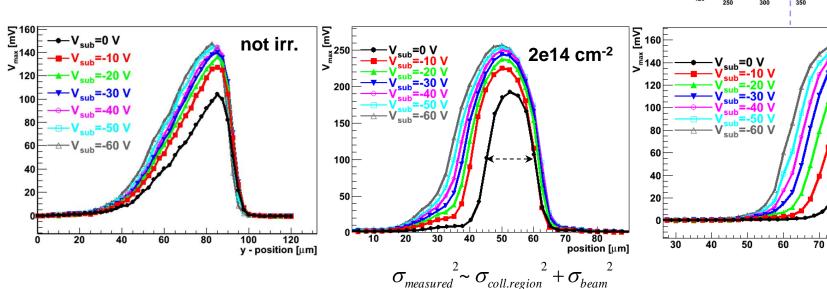


5e14 cm⁻²

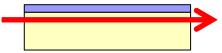
80

100

position [µm]

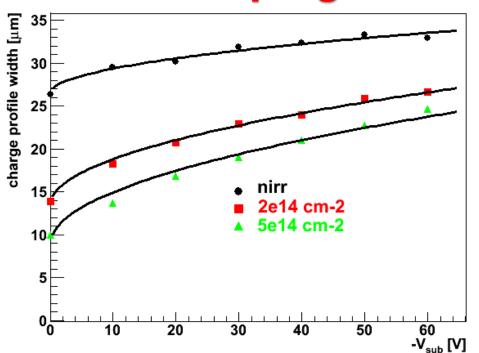


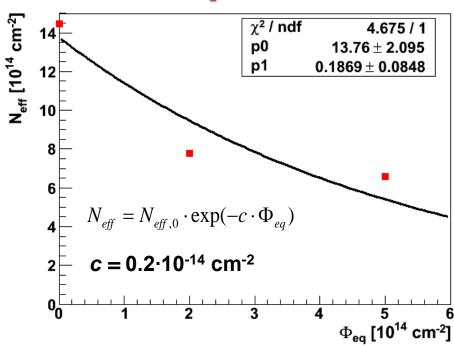
- Tail coming from diffusion before irradiation, still some after 2e14 cm-2, almost completely disappears at 5e14 cm-2
- Weak dependence of signal on voltage (beam contained in the field region)



Profile width (FWHM) is a measure of charge collection region (diffusion + depleted),
 but the width of the beam should be taken into account

Effective doping concentration in p substrate





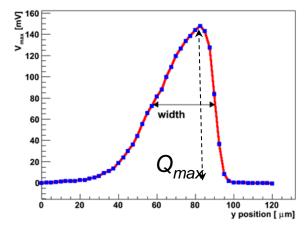
- Dependence of depleted region on substrate bias for constant space charge
 - \Box At $V_{sub}=0$ V it is assumed that charge is collected by diffusion (note the FWHM of the beam)
 - Any additional bias depletes the certain amount which adds to the diffusion contribution:

$$\Delta d = \frac{2\varepsilon\varepsilon_0}{e_0 N_{eff}} \sqrt{V_{sub}}$$

Effective doping concentration is extracted from the fit for each fluence!

The effective doping concentration seems to decrease with fluence – depletion region penetrates deeper after irradiation! This points to effective acceptor removal – not conclusive enough to claim B removal.

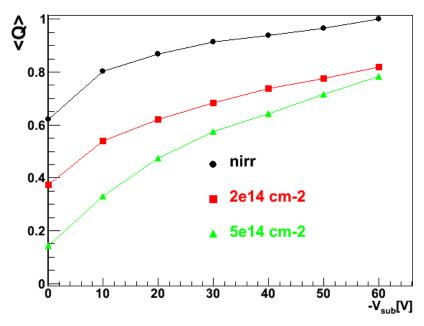
CCE for minimum ionizing particle



Integral of charge collection profile is proportional to the charge generated by minimum ionizing particle!

$$Q_{mip} \propto " = \int_{0}^{W} Q(y) \, dy"$$

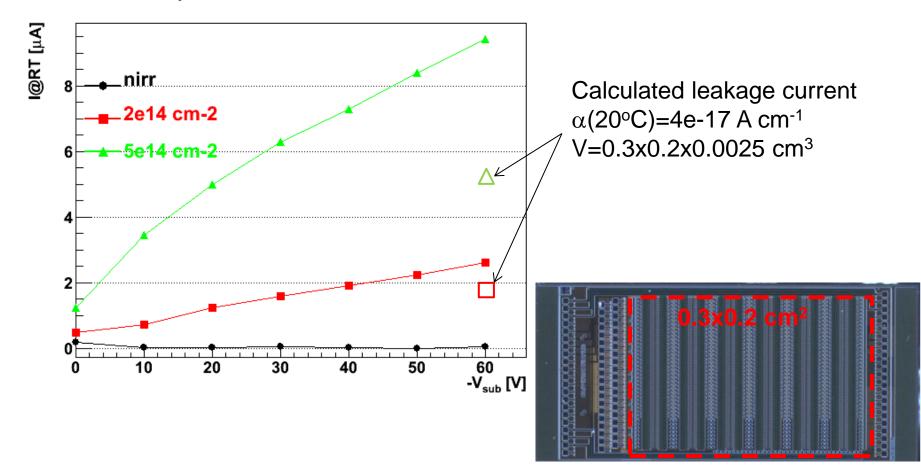
- Signals Q_{max}=Max(Q(y)) for different fluences were normalized to the same value – trapping should not play a major role at that fluences
- > <Q_{nirr}> (60 V) = 1



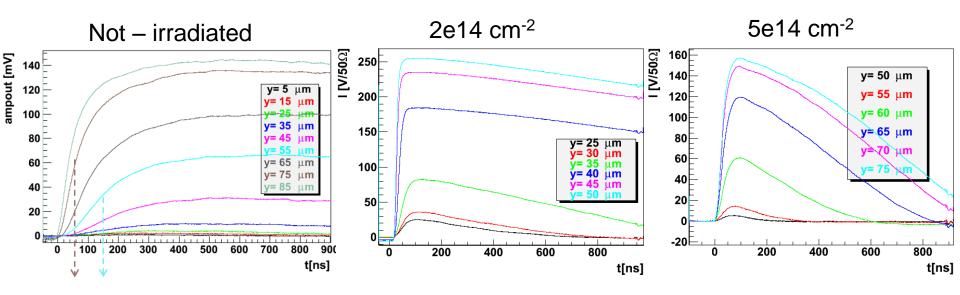
- The difference at high applied bias voltages is smaller
- The performance is far better then expected, owing to the wider depleted region
 with fast LHC speed electronics it should be better for irradiated sensors
- Almost no difference between 2e14 cm⁻² and 5e14 cm⁻² at 60 V.

Leakage current

 Temperature was not controlled/stabilized, but the room temperature was always the same 24+/-0.5C



Shapes of the amplifier response



delayed 50% crossing points in indication of contribution from diffusion

- Changes in output radiation induced?
- 50% crossing point of the max. amplitude can not be used for irradiated samples – small diffusion component/changes in amplified output



Conclusions

Edge-TCT was performed on HVCMOS2FEI4 structure using a cell amplifier output after initial amplifying stage

- Irradiation with neutrons decreases the depth from which the carrier are collected:
 - □ the depleted region **increases** with irradiation at the same bias voltage pointing to reduced N_{eff} (initial acceptor removal ?)
 - □ The "diffusion region" decreases with irradiation almost non-existent at 5e14 cm⁻²
 - □ The combined effect may be beneficial with LHC speed electronics
- Estimated charge collection efficiency after irradiation to 5e14 cm⁻² for ⁹⁰Sr changes only slightly for slow amplifier (it may increase with LHC speed electronics).
- Leakage current increase is compatible with expectations